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IXYS **MCC162-12io1**

# Thyristor Module

$V_{RRM}$ = 2x 1200 V
$I_{TAV}$ = 181 A
$V_T$ = 1.03 V

## Phase leg

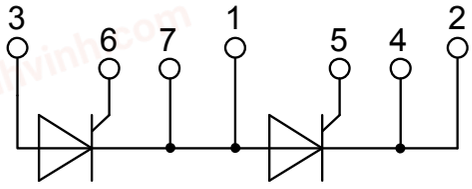
**Part number**

**MCC162-12io1**




Backside: isolated

E72873




**Features / Advantages:**

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability
- Direct Copper Bonded Al2O3-ceramic

**Applications:**

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control

**Package:** Y4

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling



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## Thyristor

| Symbol | Definition | Conditions | | Ratings min. | typ. | max. | Unit |
|---|---|---|---|---|---|---|---|
| $V_{RSM/DSM}$ | *max. non-repetitive reverse/forward blocking voltage* | | $T_{VJ}$ = 25°C | | | 1300 | V |
| $V_{RRM/DRM}$ | *max. repetitive reverse/forward blocking voltage* | | $T_{VJ}$ = 25°C | | | 1200 | V |
| $I_{R/D}$ | *reverse current, drain current* | $V_{R/D}$ = 1200 V | $T_{VJ}$ = 25°C | | | 300 | µA |
| | | $V_{R/D}$ = 1200 V | $T_{VJ}$ = 125°C | | | 10 | mA |
| $V_T$ | *forward voltage drop* | $I_T$ = 150 A | $T_{VJ}$ = 25°C | | | 1.09 | V |
| | | $I_T$ = 300 A | | | | 1.25 | V |
| | | $I_T$ = 150 A | $T_{VJ}$ = 125°C | | | 1.03 | V |
| | | $I_T$ = 300 A | | | | 1.25 | V |
| $I_{TAV}$ | *average forward current* | $T_C$ = 85°C | $T_{VJ}$ = 125°C | | | 181 | A |
| $I_{T(RMS)}$ | *RMS forward current* | 180° sine | | | | 300 | A |
| $V_{T0}$ | *threshold voltage* } *for power loss calculation only* | | $T_{VJ}$ = 125°C | | | 0.88 | V |
| $r_T$ | *slope resistance* } | | | | | 1.15 | mΩ |
| $R_{thJC}$ | *thermal resistance junction to case* | | | | | 0.155 | K/W |
| $R_{thCH}$ | *thermal resistance case to heatsink* | | | | 0.07 | | K/W |
| $P_{tot}$ | *total power dissipation* | | $T_C$ = 25°C | | | 645 | W |
| $I_{TSM}$ | *max. forward surge current* | t = 10 ms; (50 Hz), sine | $T_{VJ}$ = 45°C | | | 6.00 | kA |
| | | t = 8,3 ms; (60 Hz), sine | $V_R$ = 0 V | | | 6.48 | kA |
| | | t = 10 ms; (50 Hz), sine | $T_{VJ}$ = 125°C | | | 5.10 | kA |
| | | t = 8,3 ms; (60 Hz), sine | $V_R$ = 0 V | | | 5.51 | kA |
| $I^2t$ | *value for fusing* | t = 10 ms; (50 Hz), sine | $T_{VJ}$ = 45°C | | | 180.0 | kA²s |
| | | t = 8,3 ms; (60 Hz), sine | $V_R$ = 0 V | | | 174.7 | kA²s |
| | | t = 10 ms; (50 Hz), sine | $T_{VJ}$ = 125°C | | | 130.1 | kA²s |
| | | t = 8,3 ms; (60 Hz), sine | $V_R$ = 0 V | | | 126.3 | kA²s |
| $C_J$ | *junction capacitance* | $V_R$ = 400 V f = 1 MHz | $T_{VJ}$ = 25°C | | 273 | | pF |
| $P_{GM}$ | *max. gate power dissipation* | $t_P$ = 30 µs | $T_C$ = 125°C | | | 120 | W |
| | | $t_P$ = 500 µs | | | | 60 | W |
| $P_{GAV}$ | *average gate power dissipation* | | | | | 8 | W |
| $(di/dt)_{cr}$ | *critical rate of rise of current* | $T_{VJ}$ = 125°C; f = 50 Hz | repetitive, $I_T$ = 540 A | | | 150 | A/µs |
| | | $t_P$ = 200 µs; $di_G/dt$ = 0.5 A/µs; | | | | | |
| | | $I_G$ = 0.5 A; $V_D$ = ⅔ $V_{DRM}$ | non-repet., $I_T$ = 180 A | | | 500 | A/µs |
| $(dv/dt)_{cr}$ | *critical rate of rise of voltage* | $V_D$ = ⅔ $V_{DRM}$ | $T_{VJ}$ = 125°C | | | 1000 | V/µs |
| | | $R_{GK}$ = ∞; method 1 (linear voltage rise) | | | | | |
| $V_{GT}$ | *gate trigger voltage* | $V_D$ = 6 V | $T_{VJ}$ = 25°C | | | 2.5 | V |
| | | | $T_{VJ}$ = -40°C | | | 2.6 | V |
| $I_{GT}$ | *gate trigger current* | $V_D$ = 6 V | $T_{VJ}$ = 25°C | | | 150 | mA |
| | | | $T_{VJ}$ = -40°C | | | 200 | mA |
| $V_{GD}$ | *gate non-trigger voltage* | $V_D$ = ⅔ $V_{DRM}$ | $T_{VJ}$ = 125°C | | | 0.2 | V |
| $I_{GD}$ | *gate non-trigger current* | | | | | 10 | mA |
| $I_L$ | *latching current* | $t_p$ = 30 µs | $T_{VJ}$ = 25°C | | | 300 | mA |
| | | $I_G$ = 0.5 A; $di_G/dt$ = 0.5 A/µs | | | | | |
| $I_H$ | *holding current* | $V_D$ = 6 V $R_{GK}$ = ∞ | $T_{VJ}$ = 25°C | | | 200 | mA |
| $t_{gd}$ | *gate controlled delay time* | $V_D$ = ½ $V_{DRM}$ | $T_{VJ}$ = 25°C | | | 2 | µs |
| | | $I_G$ = 0.5 A; $di_G/dt$ = 0.5 A/µs | | | | | |
| $t_q$ | *turn-off time* | $V_R$ = 100 V; $I_T$ = 300 A; $V_D$ = ⅔ $V_{DRM}$ | $T_{VJ}$ = 125°C | | 150 | | µs |
| | | di/dt = 10 A/µs; dv/dt = 20 V/µs; $t_p$ = 200 µs | | | | | |

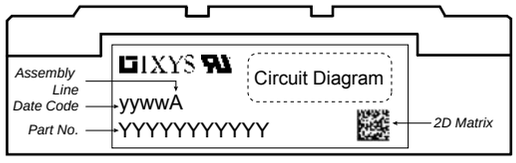


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# IXYS MCC162-12io1

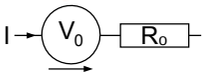
| Package Y4 | | | | Ratings | | | |
|---|---|---|---|---|---|---|---|
| Symbol | Definition | Conditions | | min. | typ. | max. | Unit |
| $I_{RMS}$ | *RMS current* | per terminal | | | | 300 | A |
| $T_{VJ}$ | *virtual junction temperature* | | | -40 | | 125 | °C |
| $T_{op}$ | *operation temperature* | | | -40 | | 100 | °C |
| $T_{stg}$ | *storage temperature* | | | -40 | | 125 | °C |
| **Weight** | | | | | 150 | | g |
| $M_D$ | *mounting torque* | | | 2.25 | | 2.75 | Nm |
| $M_T$ | *terminal torque* | | | 4.5 | | 5.5 | Nm |
| $d_{Spp/App}$ | *creepage distance on surface \| striking distance through air* | *terminal to terminal* | 14.0 | 10.0 | | | mm |
| $d_{Spb/Apb}$ | | *terminal to backside* | 16.0 | 16.0 | | | mm |
| $V_{ISOL}$ | *isolation voltage* | t = 1 second | 50/60 Hz, RMS; $I_{ISOL}$ ≤ 1 mA | 3600 | | | V |
| | | t = 1 minute | | 3000 | | | V |




| Ordering | Part Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|---|---|---|---|---|---|
| Standard | MCC162-12io1 | MCC162-12io1 | Box | 6 | 429597 |

## Equivalent Circuits for Simulation

** on die level* $T_{VJ}$ = 125 °C




**Thyristor**

| | | | |
|---|---|---|---|
| $V_{0\,max}$ | *threshold voltage* | 0.88 | V |
| $R_{0\,max}$ | *slope resistance ** | 0.8 | mΩ |

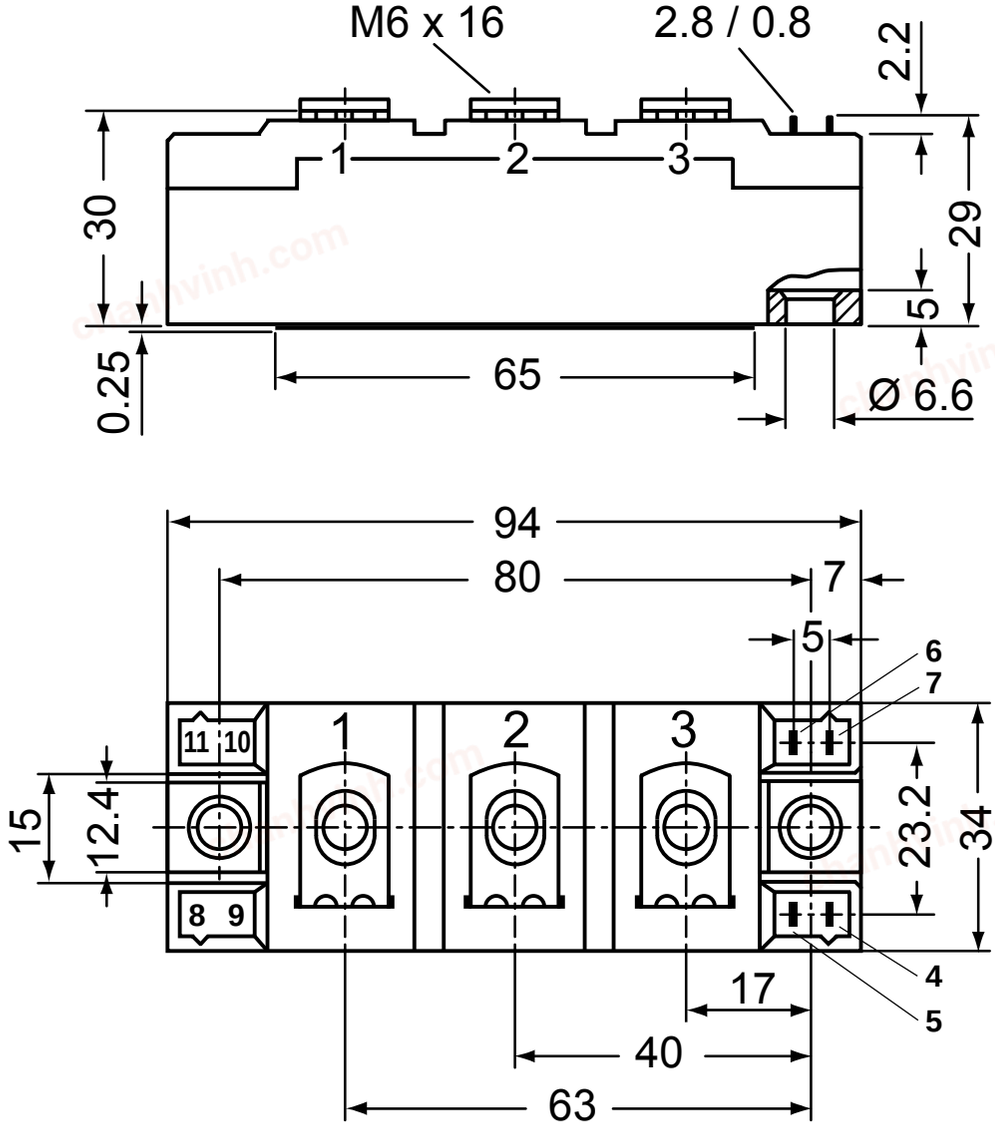


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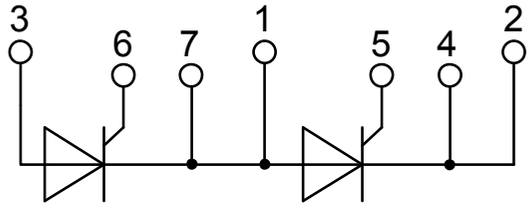
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## Outlines Y4




Optional accessories for modules
Keyed gate/cathode twin plugs with wire length = 350 mm, gate = white, cathode = red
Type ZY 180L (L = Left for pin pair 4/5)
Type ZY 180R (R = Right for pin pair 6/7) } UL 758, style 3751






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## Thyristor

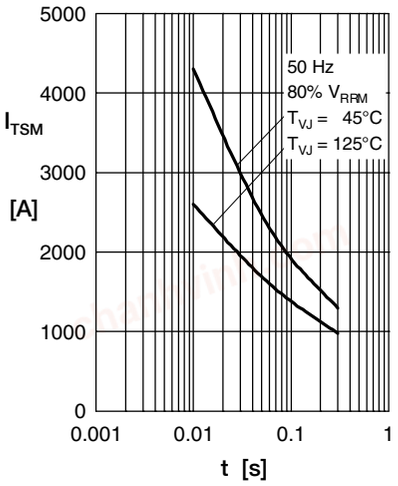



Fig. 1 Surge overload current $I_{TSM}$, $I_{FSM}$: Crest value, t: duration

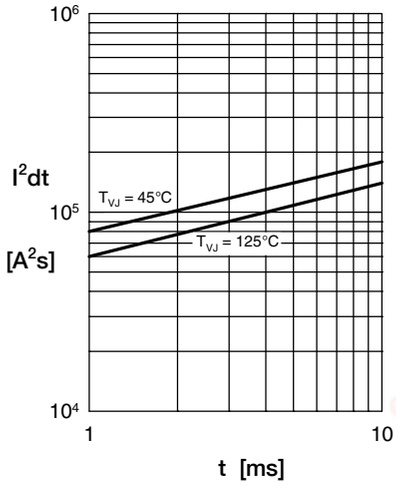



Fig. 2 $I^2t$ versus time (1-10 ms)

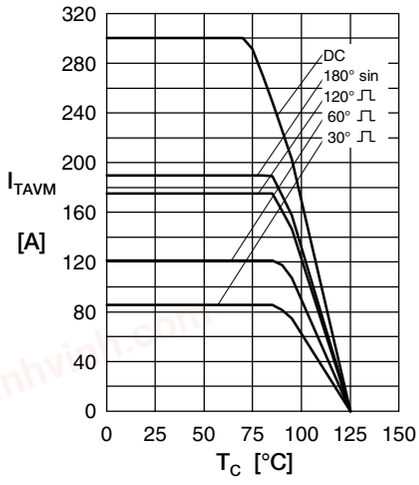



Fig. 3 Max. forward current at case temperature

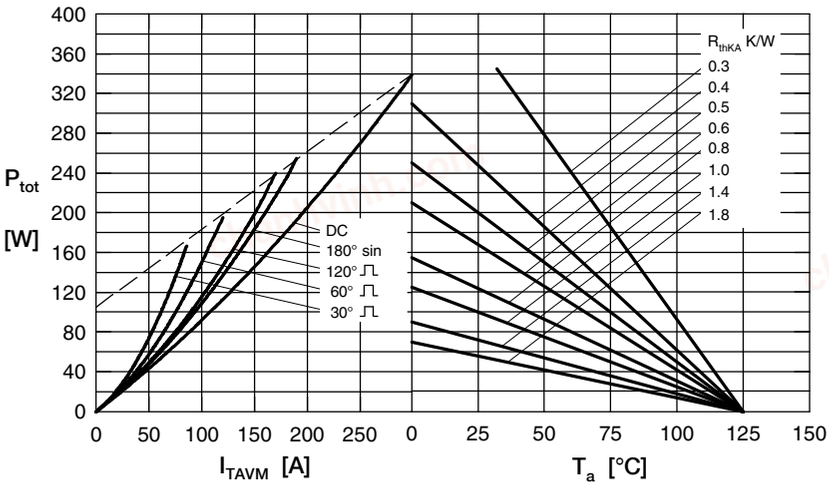



Fig. 4 Power dissipation vs. on-state current & ambient temperature (per thyristor or diode)

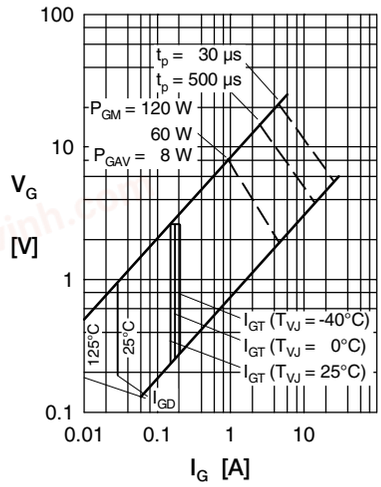



Fig. 5 Gate trigger characteristics

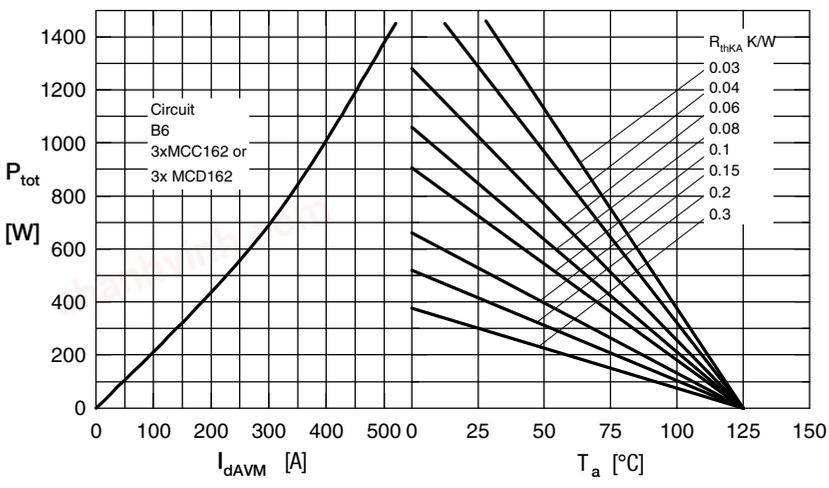



Fig. 6 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

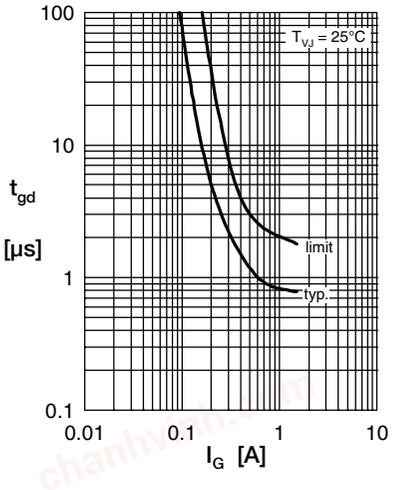



Fig. 7 Gate trigger delay time



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## Thyristor

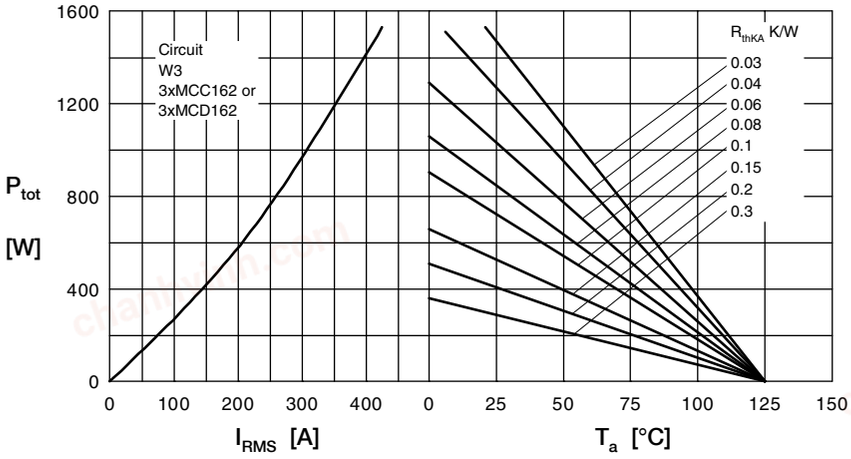



Fig. 8 Three phase AC-controller: Power dissipation versus RMS output current and ambient temperature

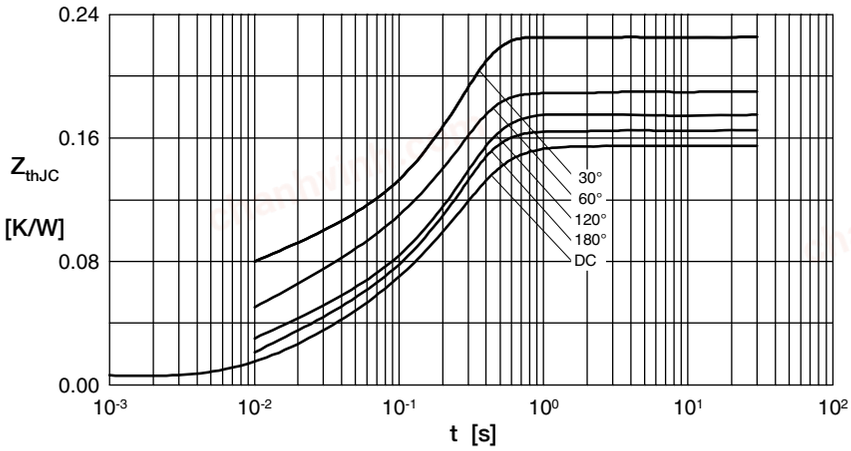



Fig. 9 Transient thermal impedance junction to case (per thyristor/diode)

$R_{thJC}$ for various conduction angles d:

| d | $R_{thJC}$ [K/W] |
|---|---|
| DC | 0.155 |
| 180° | 0.167 |
| 120° | 0.176 |
| 60° | 0.197 |
| 30° | 0.227 |

Constants for $Z_{thJC}$ calculation:

| i | $R_{thi}$ [K/W] | $t_i$ [s] |
|---|---|---|
| 1 | 0.0072 | 0.001 |
| 2 | 0.0188 | 0.080 |
| 3 | 0.1290 | 0.200 |

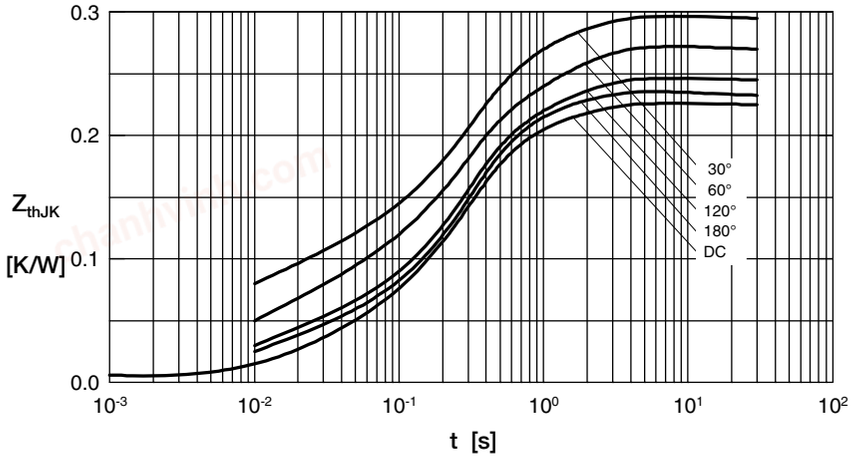



Fig. 10 Transient thermal impedance junction to heatsink (per thyristor/diode)

$R_{thJK}$ for various conduction angles d:

| d | $R_{thJK}$ [K/W] |
|---|---|
| DC | 0.225 |
| 180° | 0.237 |
| 120° | 0.246 |
| 60° | 0.267 |
| 30° | 0.297 |

Constants for $Z_{thJK}$ calculation:

| i | $R_{thi}$ [K/W] | $t_i$ [s] |
|---|---|---|
| 1 | 0.0072 | 0.001 |
| 2 | 0.0188 | 0.080 |
| 3 | 0.1290 | 0.200 |
| 4 | 0.0700 | 1.000 |



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